FEATURES

1. Ultra-miniature size (for PS pressure sensor)
2. High-level precision and linearity
3. Impressive line-up of models
   - Taking their place alongside the standard 5kΩ bridge resistance models are those with a 3.3kΩ resistance which is optimally suited to 5V drive circuits.
   - Economy model (no glass base) gives outstanding value for consumer appliances
   - 40 kPa (0.4 kgf/cm²) and 49 kPa (0.5 kgf/cm²) units are also available.

TYPICAL APPLICATIONS

(Please evaluate under actual conditions before using.)

- Industrial use (pressure switches and pneumatic devices, etc.)
- Medical use (blood pressure monitors, compressed air pressure measurement, air beds, etc.)
- Other pneumatically operated pressure devices

ORDERING INFORMATION

ADP 1 2 3 4

<Product name>
1: PF pressure sensor
4: PS pressure sensor

<Terminal profile and direction>
1: DIP terminal (Direction opposite the pressure inlet direction)
2: DIP terminal (Pressure inlet direction)

<Rated pressure>
0: 4.9 kPa
1: 34.3 kPa
2: 49.0 kPa
3: 98.1 kPa
4: 196.1 kPa
5: 343.2 kPa
6: 490.3 kPa
7: 833.6 kPa
8: 980.7 kPa
A: 40.0 kPa

>Type>
1: Standard type (With glass base)
2: Economy type (Without glass base)

<Bridge resistance>
Nil: PF 5kΩ
0: PS 5kΩ
3: 3.3kΩ

Note: Some part numbers may not be available depending on the combination. Please refer to the Table of Product Types.
## TYPES

### 1. DIP terminal

<table>
<thead>
<tr>
<th>Pressure</th>
<th>Standard type (with glass base)</th>
<th>Economy type (without glass base)</th>
</tr>
</thead>
<tbody>
<tr>
<td>4.9 kPa</td>
<td>ADP41010 ADP42010</td>
<td>—</td>
</tr>
<tr>
<td>34.3 kPa</td>
<td>ADP41210 ADP42210</td>
<td>ADP41A23 ADP42A23</td>
</tr>
<tr>
<td>49.0 kPa</td>
<td>ADP41310 ADP42310</td>
<td>ADP41A23 ADP42A23</td>
</tr>
<tr>
<td>98.1 kPa</td>
<td>ADP41410 ADP42410 ADP41413 ADP42413</td>
<td>ADP41141 ADP42141</td>
</tr>
<tr>
<td>196.1 kPa</td>
<td>ADP41510 ADP42510</td>
<td>ADP41151 ADP42151</td>
</tr>
<tr>
<td>343.2 kPa</td>
<td>ADP41610 ADP42610</td>
<td>ADP41161 ADP42161</td>
</tr>
<tr>
<td>490.3 kPa</td>
<td>ADP41710 ADP42710</td>
<td>ADP41171 ADP42171</td>
</tr>
<tr>
<td>833.6 kPa</td>
<td>ADP41810 ADP42810</td>
<td>ADP41811 ADP42811</td>
</tr>
<tr>
<td>980.7 kPa</td>
<td>ADP41910 ADP42910 ADP41913 ADP42913</td>
<td>ADP41191 ADP42191</td>
</tr>
<tr>
<td>40.0 kPa</td>
<td>—</td>
<td>ADP11A23 ADP12A23</td>
</tr>
</tbody>
</table>

### Notes:

1. Unless otherwise specified, measurements were taken with a drive current of ±0.01 mA and humidity ranging from 25% to 85%.
2. Please consult us if a pressure medium other than air is to be used.
3. For PS pressure sensor only.
4. This is the regulation which applies within the compensation temperature range.
5. Please consult us if the intended use involves a negative pressure.

### Standard packing:

- Carton: 100 pcs.; Case: 1,000 pcs.
REFERENCE DATA

[PS pressure sensor]

1. Characteristics data

1.-(1) Output characteristics

ADP41913
Drive current: 1.0 mA; temperature: 30°C 86°F

1.-(2) Offset voltage – temperature characteristics

ADP41913
Drive current: 1.0 mA; rating ±3.5%FS

1.-(3) Sensitivity – temperature characteristics

ADP41913
Drive current: 1.0 mA; rating ±2.5%FS

2. Pressure cycle range (0 to rated pressure)

Tested sample: ADP41913, temperature: 100°C 212°F, No. of cycle: 1×10⁶

Offset voltage range

Even after testing for 1 million times, the variations in the offset voltage and output span voltage are minimal.

[PF pressure sensor]

1. Characteristics data

1.-(1) Output characteristics

ADP1141
Drive current: 1.5 mA; temperature: 25°C 77°F

1.-(2) Offset voltage – temperature characteristics

ADP1141
Drive current: 1.5 mA; rating ±5%FS

1.-(3) Sensitivity – temperature characteristics

ADP1141
Drive current: 1.5 mA; rating ±2.5%FS
2. Pressure cycle range (0 to rated pressure)
Tested sample: ADP1131, temperature: 25°C 77°F
Offset voltage range

<table>
<thead>
<tr>
<th>Pressure cycle range (%FS)</th>
<th>1×10^5</th>
<th>5×10^5</th>
<th>1×10^6</th>
</tr>
</thead>
<tbody>
<tr>
<td>Offset voltage range (%)</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output span voltage range</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Even after testing for 1 million times, the variations in the offset voltage and output span voltage are minimal.

### Evaluation test

<table>
<thead>
<tr>
<th>Classification</th>
<th>Tested item</th>
<th>Tested condition</th>
<th>Result</th>
</tr>
</thead>
<tbody>
<tr>
<td>Environmental</td>
<td>Storage at high temperature</td>
<td>Temperature: Left in a 120°C 248°F constant temperature bath Time: 1,000 hrs.</td>
<td>Passed</td>
</tr>
<tr>
<td>characteristics</td>
<td>Storage at low temperature</td>
<td>Temperature: Left in a –40°C –40°F constant temperature bath Time: 1,000 hrs.</td>
<td>Passed</td>
</tr>
<tr>
<td></td>
<td>Humidity</td>
<td>Temperature/humidity: Left at 40°C 104°F, 90% RH Time: 1,000 hrs.</td>
<td>Passed</td>
</tr>
<tr>
<td></td>
<td>Temperature cycle</td>
<td>Temperature: –40°C to 120°C –40°F to 248°F 1 cycle: 30 Min. Times of cycle: 100</td>
<td>Passed</td>
</tr>
<tr>
<td>Endurance</td>
<td>High temperature/high humidity operation</td>
<td>Temperature/humidity: 40°C 104°F, 90% RH Operation times: 10^6, rated voltage applied</td>
<td>Passed</td>
</tr>
<tr>
<td>characteristics</td>
<td>Vibration resistance</td>
<td>Double amplitude: 1.5 mm 0.059 inch Vibration: 10 to 55 Hz Applied vibration direction: X, Y, Z 3 directions Times: 2 hrs each</td>
<td>Passed</td>
</tr>
<tr>
<td></td>
<td>Dropping resistance</td>
<td>Dropping height: 75 cm 29.528 inch Times: 2 times</td>
<td>Passed</td>
</tr>
<tr>
<td></td>
<td>Terminal strength</td>
<td>Pulling strength: 9.8 N (1 kgf), 10 sec. Bending strength: 4.9 N (0.5 kgf), left and right 90° 1 time</td>
<td>Passed</td>
</tr>
<tr>
<td>Soldering</td>
<td>Soldered in DIP soldering bath</td>
<td>Temperature: 230°C 446°F Time: 5 sec.</td>
<td>Passed</td>
</tr>
<tr>
<td>resistance</td>
<td>Temperature</td>
<td>Temperature: 260°C 500°F Time: 10 sec.</td>
<td>Passed</td>
</tr>
</tbody>
</table>

Note: For details other than listed above, please consult us.
1. Terminal direction: DIP terminal Direction opposite the pressure inlet direction ADP41

Recommended PC board pattern (BOTTOM VIEW)

Terminal connection diagram

<table>
<thead>
<tr>
<th>Terminal No.</th>
<th>Name</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Power supply (+)</td>
</tr>
<tr>
<td>2</td>
<td>Output (+)</td>
</tr>
<tr>
<td>3</td>
<td>Power supply (–)</td>
</tr>
<tr>
<td>4</td>
<td>Power supply (–)</td>
</tr>
<tr>
<td>5</td>
<td>Output (–)</td>
</tr>
<tr>
<td>6</td>
<td>No connection</td>
</tr>
</tbody>
</table>

Note: Leave terminal 6 unconnected.

2. Terminal direction: DIP terminal Pressure inlet direction ADP42

Recommended PC board pattern (BOTTOM VIEW)

Terminal connection diagram

<table>
<thead>
<tr>
<th>Terminal No.</th>
<th>Name</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
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</tr>
<tr>
<td>4</td>
<td>Power supply (–)</td>
</tr>
<tr>
<td>5</td>
<td>Output (–)</td>
</tr>
<tr>
<td>6</td>
<td>No connection</td>
</tr>
</tbody>
</table>

Note: Leave terminal 6 unconnected.
1. Terminal direction: Direction opposite the pressure inlet direction ADP11

Recommended PC board pattern (BOTTOM VIEW)

Terminal connection diagram

General tolerance: ±0.3 ±0.012

Note: Leave terminal 4 unconnected.

2. Terminal direction: Pressure inlet direction ADP12

Recommended PC board pattern (BOTTOM VIEW)

Terminal connection diagram

General tolerance: ±0.3 ±0.012

Note: Leave terminal 4 unconnected.
NOTES

1. Mounting
Use lands on the PC boards to which the sensor can be securely fixed.

2. Soldering
Due to its small size, the thermal capacity of the pressure sensor DIP type is low. Therefore, take steps to minimize the effects of external heat. Damage and changes to characteristics may occur due to heat deformation. Use a non-corrosive resin type of flux. Since the pressure sensor DIP type is exposed to the atmosphere, do not allow flux to enter inside.

1) Manual soldering
- Set the soldering tip from 260 to 300°C (500 to 572°F) (30W), and solder for no more than 5 seconds.
- Please note that output may change if the pressure is applied on the terminals when the soldering.
- Thoroughly clean the soldering iron.
2) DIP soldering (DIP terminal type)
- Please use a soldering iron that is not add more flux when reworking.
- Please use a soldering iron that is below the temperature given in the specifications in order to maintain the correct temperature at the tip of the soldering iron.
- When mounting onto a PCB of low thermal capacity, please avoid DIP soldering as this may cause heat deformity.
3) Solder reworking
- Finish reworking in one operation.
- For reworking of the solder bridge, use a soldering iron with a flat tip. Please do not add more flux when reworking.
- Please use a soldering iron that is below the temperature given in the specifications in order to maintain the correct temperature at the tip of the soldering iron.
4) Too much force on the terminals will cause deformation and loss in effectiveness of the solder. Therefore, please avoid dropping and careless handling of the product.
5) Please control warping of the PCB within 0.05 mm of the sensor width.
6) When cut folding the PCB after mounting the sensor, take measures to prevent stress to the soldered parts.
7) The sensor terminals are designed to be exposed, so contact of the terminals with metal shards and the like will cause output errors. Therefore, please be careful and prevent things such as metal shards and hands from contacting the terminals.
8) To prevent degradation of the PCB insulation after soldering, please be careful not to get chemicals on the sensor when coating.
9) Please consult us regarding the use of lead-free solder.

3. Cleaning
1) Since the pressure sensor chip is exposed to the atmosphere, do not allow cleaning fluid to enter inside.
2) Avoid ultrasonic cleaning since this may cause breaks or disconnections in the wiring.

4. Environment
1) Please avoid using or storing the pressure sensor chip in a place exposed to corrosive gases (such as the gases given off by organic solvents, sulfuric acid gas, hydrogen sulfides, etc.) which will adversely affect the performance of the pressure sensor chip.
2) Since this pressure sensor chip does not have a water-proof construction, please do not use the sensor in a location where it may be sprayed with water, etc.
3) Avoid using the pressure sensors chip in an environment where condensation may form. Furthermore, its output may fluctuate if any moisture adhering to it freezes.
4) The pressure sensor chip is constructed in such a way that its output will fluctuate when it is exposed to light. Especially when pressure is to be applied by means of a transparent tube, take steps to prevent the pressure sensor chip from being exposed to light.
5) Avoid using the pressure sensor chip where it will be susceptible to ultrasonic or other high-frequency vibration.

5. Quality check under actual loading conditions
To assure reliability, check the sensor under actual loading conditions. Avoid any situation that may adversely affect its performance.

6. Other handling precautions
1) That using the wrong pressure range or mounting method may result in accidents.
2) The only direct pressure medium you can use is dry air. The use of other media, in particular, corrosive gases (organic solvent based gases, sulfuric acid based gases, and hydrogen sulfide based gases, etc.) and media that contains moisture or foreign substances will cause malfunction and damage. Please do not use them.
3) The pressure sensor chip is positioned inside the pressure inlet. Never poke wires or other foreign matter through the pressure inlet since they may damage the chip or block the inlet. Avoid use when the atmospheric pressure inlet is blocked.
4) Use an operating pressure which is within the rated pressure range. Using a pressure beyond this range may cause damage.
5) Since static charge can damage the pressure sensor chip, bear in mind the following handling precautions.
   1) When storing the pressure sensor chips, use a conductive material to short the pins or wrap the entire chip in aluminum foil. Plastic containers should not be used to store or transport the chips since they readily become charged.
   2) When using the pressure sensor chips, all the charged articles on the bench surface and the work personnel should be grounded so that any ambient static will be safely discharged.
6) Based on the pressure involved, give due consideration to the securing of the pressure sensor DIP type and to the securing and selection of the inlet tube. Consult us if you have any queries.
APPLICATION CIRCUIT DIAGRAM (EXAMPLE)

The pressure sensor is designed to convert a voltage by means of constant current drive and then, if necessary, it amplifies the voltage for use. The circuit shown below is a typical example of a circuit in which the pressure sensor is used.

MOUNTING METHOD

The general method for transmitting air pressures differs depending on whether the pressure is low or high.

- **Checkpoints for use**
  1. Select a pressure inlet pipe which is sturdy enough to prevent pressure leaks.
  2. Fix the pressure inlet pipe securely so as to prevent pressure leaks.
  3. Do not block the pressure inlet pipe.

Methods of transmitting air pressures

- **When the pressure is low**
  - (4.9 to 98.1 kPa)
- **When the pressure is high**
  - (196.1 to 980.7 kPa)

- Tube
- If a tube is used as the pressure inlet pipe, it may become disengaged. Therefore, use a sturdy tube and secure it using O-rings.